## MLCC Tin/Lead Termination "B" (LD Series)







AVX Corporation will support those customers for commercial and military Multilayer Ceramic Capacitors with a termination consisting of 5% minimum lead. This termination is indicated by the use of a "B" in the 12th position of the AVX Catalog Part Number. This fulfills AVX's commitment to providing a full range of products to our customers. AVX has provided in the following pages a full range of values that we are currently offering in this special "B" termination. Please contact the factory if you require additional information on our MLCC Tin/Lead Termination "B" products.

#### PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)

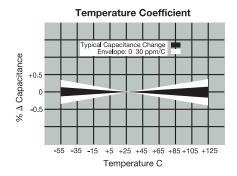
**Not RoHS Compliant** 

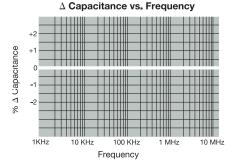
LD05	5	Α	101	J	Α	В	2	Α
	T	T	T	T	T	T	T	Т
Size	Voltage	Dielectric	Capacitance	Capacitance	Failure	Terminations	Packaging	Special
LD02 - 0402 LD03 - 0603	6.3V = 6 10V = Z	C0G (NP0) = A X7R = C	Code (In pF) 2 Sig. Digits +	Tolerance	<b>Rate</b> A = Not	B = 5% min lead X = FLEXITERM®	2 = 7" Reel 4 = 13" Reel	<b>Code</b> A = Std.
LD04 - 0504*	16V = Y	X5R = D	Number of	$B = \pm .10 pF (<10pF)$ $C = \pm .25 pF (<10pF)$	Applicable	with 5% min		Product
LD05 - 0805 LD06 - 1206	25V = 3	X8R = F	Zeros	$D = \pm .50 \text{ pF} (<10 \text{pF})$	4 = Automotive	lead**	Contact Factory	
LD10 - 1210	35V = D			F = ±1% (≥ 10 pF)			For Multiples*	
LD12 - 1812	50V = 5			G = ±2% (≥ 10 pF)		**X7R only	Multiples	
LD13 - 1825	100V = 1			J = ±5%				
LD14 - 2225 LD20 - 2220	200V = 2 500V = 7			K = ±10%				
LD20 - 2220	300V - 7			M = ±20%				

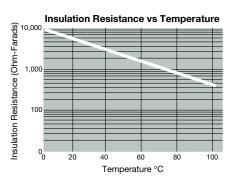
\*LD04 has the same CV ranges as LD03.

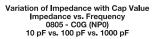
See FLEXITERM® section for CV options

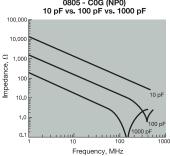
NOTE: Contact factory for availability of Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

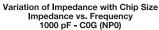


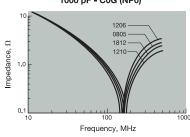




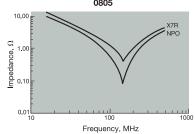








Variation of Impedance with Ceramic Formulation Impedance vs. Frequency 1000 pF - C0G (NP0) vs X7R



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# **MLCC Tin/Lead Termination "B"**



## C0G (NP0) - Specifications and Test Methods

Parame	ter/Test	NP0 Specification Limits	Measuring Conditions						
Operating Tem	perature Range	-55°C to +125°C	Temperature Cycle Chamber						
Capac	itance	Within specified tolerance	Freq.: 1.0 MHz ± 10	% for cap ≤ 1000 pF					
(	2	<30 pF: Q≥ 400+20 x Cap Value ≥30 pF: Q≥ 1000	1.0 kHz ± 10% for cap > 1000 pF Voltage: 1.0Vrms ± .2V						
Insulation	Resistance	100,000MΩ or 1000MΩ - μF, whichever is less	Charge device with rated voltage for 60 ± 5 secs @ room temp/humidity						
Dielectric	: Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.						
Resistance to	Appearance	No defects	Deflection: 2mm						
	Capacitance Variation	±5% or ±.5 pF, whichever is greater	Test Time: 3	30 seconds 7 1mm/sec					
Stresses	Q	Meets Initial Values (As Above)							
	Insulation Resistance	≥ Initial Value x 0.3	90						
Solder	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutection for 5.0 ± 0.						
	Appearance	No defects, <25% leaching of either end terminal							
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Dip device in eutectic solder at 260°C for 60 seconds. Store at room temperature for 24 ± 2						
Resistance to Solder Heat	Q	Meets Initial Values (As Above)							
Soluei Heat	Insulation Resistance	Meets Initial Values (As Above)	hours before measurin	g electrical properties.					
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes					
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Step 2: Room Temp	≤ 3 minutes					
Thermal Shock	Q	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes					
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes					
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 hours at room temperature						
	Appearance	No visual defects							
	Capacitance Variation	≤ ±3.0% or ± .3 pF, whichever is greater	Charge device with twice rated voltage in test chamber set at 125°C ± 2°C for 1000 hours (+48, -0).  Remove from test chamber and stabilize at room						
Load Life	Q	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	temperature before me	for 24 hours					
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects							
	Capacitance Variation	≤ ±5.0% or ± .5 pF, whichever is greater	Store in a test chamber s	set at 85°C ± 2°C/ 85% -					
Load Humidity	Q	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	5% relative humidity for 1000 hours (+48, -0) with rated voltage applied.  Remove from chamber and stabilize at room temperature for 24 ± 2 hours before measuring.						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)							
	Dielectric Strength	Meets Initial Values (As Above)							

## **MLCC Tin/Lead Termination "B"**





### **PREFERRED SIZES ARE SHADED**

SIZE	LD02			LD03						LD05			LD06								
Soldering Reflow/Wave Packaging All Paper						//Wave				flow/Wa	Reflow/Wave Paper/Embossed										
	mm		.00 ± 0.1		All Paper 1.60 ± 0.15			Paper/Embossed 2.01 ± 0.20					3.20 ± 0.20								
(L) Length	(in.)	(0.0	40 ± 0.0	04)	(0.063 ± 0.006)				(0.079 ± 0.008)					(0.126 ± 0.008)							
W) Width	mm		.50 ± 0.1 )20 ± 0.0		0.81 ± 0.15 (0.032 ± 0.006)			1.25 ± 0.20 (0.049 ± 0.008)					1.60 ± 0.20 (0.063 ± 0.008)								
- · · ·	(in.) mm		.25 ± 0.0				± 0.000) ± 0.15				.50 ± 0.0					0.50 ±					
(t) Terminal	(in.)	(0.0	10 ± 0.0	06)		(0.014 :				(0.0	020 ± 0.0	10)				(0.020 ±	0.010)				
	WVDC	16	25	50	16	25	50	100	16	25	50	100	200	16	25	50	100	200	500		
Cap (pF)	0.5 1.0	C	СС	СС	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J		
(4.)	1.2	C	C	c	G	G	G	G	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	J	J	J		
	1.5	C	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	1.8 2.2	С	0 0	0 0	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J		
	2.7	С	С	С	Ğ	Ğ	Ğ	Ğ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ		
	3.3	0	0 0	C	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	3.9 4.7	C	C C	C	G G	G G	G G	G G	J	J	J	J   J	J	J	J	J	J	J	J		
	5.6	С	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	6.8	С	C	C	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	8.2 10	C	C	C	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J		
	12	С	С	С	G	G	G	G	Ĵ	J	Ĵ	J	J	J	Ĵ	J	J	Ĵ	J		
	15	С	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	18 22	C C	C	C	G G	G G	G G	G G	J	J	J	J   J	J	J	J	J	J	J	J		
	27	С	С	С	G	G	G	G	J	Ĵ	J	J	Ĵ	J	J	J	J	J	J		
	33	С	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	39 47	C	C	C	G G	G G	G G	G G	J	J	J	J   J	J   J	J	J	J	J	J	J		
	56	C	C	C	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	68	С	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	100	C	C	C	G G	G G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	120	С	С	С	G	G	G	G	Ĵ	Ĵ	J	Ĵ	Ĵ	Ĵ	J	J	Ĵ	Ĵ	J		
	150	С	С	С	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J		
	180 220	C	C	CC	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J M		
	270	С	С	С	G	G	G	G	Ĵ	Ĵ	Ĵ	Ĵ	М	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	М		
	330 390	00	С	С	G G	G G	G G	G G	J	J	J	J	M	J	J	J	J	J	M		
	470	C	C	C	G	G	G	G	J	J	J	J   J	M M	J J	J	J	J	J   J	M M		
	560				G	G	G		J	J	J	J	M	J	J	J	J	J	М		
	680				G	G G	G		J	J	J	J		J J	J	J	J	J M	Р		
	820 1000				G G	G	G		J	J	J	J		J	J	J	J	Q	$\vdash$		
	1200					G			J	J	J			J	J	J	J	Q			
	1500 1800								J	J	J			J	J	J M	M	Q	$\vdash\vdash\vdash$		
	2200								J	J	N			J	J	M	P				
	2700								J	J	N			J	J	М	Р		$\sqcup \sqcup$		
	3300 3900								J	J				J	J	M M	P P				
	4700								J	J				J	J	M	P				
	5600													J	J	М					
	6800 8200													M M	M M						
Сар	0.010													M	M		<u> </u>		$\vdash$		
(pF)	0.012																				
	0.015 0.018		-	-I-		<b>₩</b> -	_										-				
	0.022		~				ÎT														
	0.027		L (			الر	₹'_												$\sqcup$		
	0.033		`		_																
	0.039				4																
	0.068		Γ,			I	. –														
	0.082 0.1																				
	WVDC	16	25	50	16	25	50	100	16	25	50	100	200	16	25	50	100	200	500		
	SIZE		LD02				03				LD05					LDO					

Letter	Α	С	Е	G	J	K	М	N	Р	Q	Х	Υ	Z			
Max.	0.33	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79			
Thickness	(0.013)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)			
	PAPER						EMBOSSED									

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## **MLCC Tin/Lead Termination "B"**



### C0G (NP0) - Capacitance Range

### **PREFERRED SIZES ARE SHADED**

SIZI	E			LD10			LD12						LD1	3			LD14		
Solder	ring		F	Reflow Or	ıly		Reflow Only						Reflow	Only		Reflow Only			
Packag	ging mm	Paper/Embossed 3.20 + 0.20						I Emboss 4.50 ± 0.3			All Embossed 4.50 ± 0.30				All Embossed 5.72 ± 0.25				
(L) Length	(in.)		(0.	126 ± 0.0	(80			(0.	177 ± 0.0	12)			(0.177 ±	0.012)		(0.225 ± 0.010)			
W) Width	mm (in.)		(0.	2.50 ± 0.2 .098 ± 0.0	(800			(0.	3.20 ± 0.2 126 ± 0.0	(800			6.40 ± (0.252 ± )	0.016)		6.35 ± 0.25 (0.250 ± 0.010)			
(t) Terminal	mm (in.)			0.50 ± 0.2 .020 ± 0.0					0.61 ± 0.3 024 ± 0.0				0.61 ± (0.024 ± )				0.64 ± 0.39 (0.025 ± 0.015	)	
Сар	WVDC 0.5	25	50	100	200	500	25	50	100	200	500	50	100		200	50	100	200	
(pF)	1.0																		
	1.2 1.5																		
	1.8 2.2																7	TAV.	
	2.7															_ <		~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	
	3.3 3.9																		
	4.7 5.6															_ `			
	6.8																*t		
	8.2 10					J													
	12 15					J													
	18					J													
	22 27					J													
	33 39					J													
	47 56					J							-						
	68					J													
	82 100					J													
	120 150					J													
	180					J													
	220 270					J													
	330 390					J M													
	470					М													
	560 680	J	J	J	J	M M													
	820 1000	J J	J	J	J	M M	K	K	К	K	M	M	M		M	M	M	Р	
	1200	J	J	J	М	М	K	K	K	K	М	M	М		М	М	М	Р	
	1500 1800	J J	J	J	M	М	K	K	K K	K K	M M	M M	M		M M	M M	M M	P P	
	2200 2700	J J	J	J	Q Q		K K	K	K K	K P	P Q	M M	M M		M M	M M	M M	P P	
	3300 3900	J	J	J	×		P P	P	P P	P P	Q	М	М		M M	М	М	P P	
	4700	J	J	M M			Р	P	Р	P	Ŷ	M M	M M		М	M M	M M	P	
	5600 6800	J	J				P P	P P	P Q	P Q	Y	M M	M M		M M	M M	M M	P P	
Сар	8200 0.010	J J	J	$\vdash$			P P	P P	Q Q	Q Q	Y	M M	M			M M	M M	P P	
(pF)	0.012	Ĵ	Ĵ				Р Р	P P	Q	Х	Y	М	М			М	М	P	
	0.015 0.018						Р	Р	Q X	X	Y	M P	M M			M M	M M	Y	
	0.022 0.027						P Q	P X	X X	X Z		P P				M P	Y Y	Y	
	0.033						Q	X	Х	Z		Р				Р			
	0.039 0.047						X X	X	Z Z	Z Z		P P				P P			
	0.068 0.082						Z Z	Z Z	Z Z							P Q			
	0.1 WVDC	25	50	100	200	500	Z 25	Z 50	Z 100	200	500	50	100		200	Q 50	100	200	
SIZ		20		LD10	200	300	23	, 30	LD12	200	. 500	30	LD1			30	LD14	200	
Letter Max.	0.33	0.5		E 0.71	G 0.90	0.9		1.02	M 1.27		.40	P 1.52	Q 1.78	2.29	Y 2.54	2.79	+		
Max. Thickness	(0.013)	(0.02		0.71	(0.035)	(0.03		(0.040)	(0.050		055)	(0.060)	(0.070)	(0.090)	(0.100				
				PAPER								EMBOS							